# mail

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## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



### TVS Diode Arrays (SPA® Diodes)

Lightning Surge Protection- SP4022 Series



## SP4022 Series 1.3pF, 15A Discrete TVS Diode

AUTOMOTIVE GRADE ROHS (PG) GREEN



#### Pinout



#### Description

The SP4022 series integrates low capacitance steering diodes with one or two zener diodes for unidirectional or bidirectional protection, respectively, to protect against ESD and lightning induced surge events. These devices can safely absorb up to 15A per IEC 61000-4-5 2nd Edition ( $t_p$ =8/20µs) without performance degradation and a minimum ±30kV ESD per IEC61000-4-2 International Standard. The low loading capacitance and high surge capability make it ideal for protecting telecommunication ports such as xDSL and other high voltage, high speed legacy interfaces.

#### Features

- ESD, IEC 61000-4-2, ±30kV contact, ±30kV air
- EFT, IEC 61000-4-4, 40A (5/50ns)
- Lightning, IEC 61000-4-5 2nd Edition, 15A (t<sub>p</sub>=8/20µs)
- Low capacitance of 1.3pF (@V<sub>B</sub>=0V)
- Low leakage current
- Unidirectional and Bidirectional configuration
- Small SOD323 package fits 0805 footprints
- AEC-Q101 qualified
- RoHS Compliant and Lead Free

#### **Functional Block Diagram**



Bidirectional SP4022-01FTG-C

#### Applications

- xDSL Interfaces
- RS-232
- RS-485
- Power Ports
- Security Equipment
- Instrumentation
- Medical Equipment
- Computers and Peripherals

#### Additional Information







Samples

Life Support Note:

#### Not Intended for Use in Life Support or Life Saving Applications

The products shown herein are not designed for use in life sustaining or life saving applications unless otherwise expressly indicated.

SP4022-01FTG

#### **Absolute Maximum Ratings**

Symbol	Parameter	Value	Units
I <sub>PP</sub>	Peak Current (t <sub>p</sub> =8/20µs)	15	А
P <sub>Pk</sub>	Peak Pulse Power (t <sub>p</sub> =8/20µs)	500	W
T <sub>op</sub>	Operating Temperature	-40 to 150	°C
T	Storage Temperature	-55 to 150	°C

Notes:

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

#### **Thermal Information**

Parameter	Rating	Units
Storage Temperature Range	-55 to 150	°C
Maximum Junction Temperature	150	°C
Maximum Lead Temperature (Soldering 20-40s)	260	°C

#### Electrical Characteristics (T<sub>OP</sub>=25°C)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Units
Reverse Standoff Voltage	V <sub>RWM</sub>	$I_{R} \le 1\mu A$ with Pin 1 to Pin 2			12	V
Breakdown Voltage	V <sub>BD</sub>	$I_T = 1$ mA with Pin 1 to Pin 2	13.3			V
Leakage Current	I <sub>leak</sub>	$V_{R}$ =12V with Pin 1 to Pin 2			0.1	μA
	V <sub>c</sub>	$I_{pp}$ =1A, $t_p$ =8/20µs, Fwd		19		V
Clamp Voltage <sup>1</sup>		$I_{pp}$ =2A, $t_p$ =8/20µs, Fwd		20		V
		I <sub>PP</sub> =10A, t <sub>p</sub> =8/20μs, Fwd		28		V
		$I_{pp}$ =15A, $t_p$ =8/20µs, Fwd		33	35	V
Dynamic Resistance <sup>2</sup>	R <sub>dyn</sub>	TLP $t_p$ =100ns, Pin 1 to Pin 2		0.5		Ω
ESD Withstand Voltage <sup>1</sup>	V	IEC61000-4-2 (Contact Discharge)	±30			kV
	V ESD	IEC61000-4-2 (Air Discharge)	±30			kV
Diode Capacitance <sup>1</sup>	C <sub>D</sub>	Reverse Bias=0V, f=1MHz, Pin 1 to Pin 2		1.3	2	pF

Note:

1 Parameter is guaranteed by design and/or device characterization.

2 Transmission Line Pulse (TLP) test setting : Std.TDR(50Ω),tp=100ns, tr=0.2ns ITLP and VTLP averaging window: star t1=70ns to end t2=80ns

#### 8/20 µs Pulse Waveform



#### Capacitance vs. Reverse Bias (Pin 1 to Pin 2)



Lightning Surge Protection- SP4022 Series



#### Clamping Voltage vs. Peak Pulse Current (Pin 1 to Pin 2)



#### **Soldering Parameters**

Reflow Cor	ndition	Pb – Free assembly
	-Temperature Min (T <sub>s(min)</sub> )	150°C
Pre Heat	-Temperature Max (T <sub>s(max)</sub> )	200°C
	-Time (min to max) (t <sub>s</sub> )	60 – 180 secs
Average ra to peak	mp up rate (Liquidus) Temp ( $T_L$ )	3°C/second max
$T_{S(max)}$ to $T_{L}$ - Ramp-up Rate		3°C/second max
Poflow	-Temperature (T <sub>L</sub> ) (Liquidus)	217°C
nellow	-Temperature (t <sub>L</sub> )	60 – 150 seconds
Peak Temp	erature (T <sub>P</sub> )	260 <sup>+0/-5</sup> °C
Time within Temperatu	n 5°C of actual peak re (t <sub>p</sub> )	20 – 40 seconds
Ramp-down Rate		6°C/second max
Time 25°C to peak Temperature ( $T_P$ )		8 minutes Max.
Do not exceed		260°C

#### **Product Characteristics**

Lead Plating	Matte Tin
Lead Material	Copper Alloy
Lead Coplanarity	0.0004 inches (0.102mm)
Substrate material	Silicon
Body Material	V-0 per UL 94 Molded Epoxy

Notes ·

1. All dimensions are in millimeters

Dimensions include solder plating.
Dimensions are exclusive of mold flash & metal burr.
Bio is facing up for mold and facing down for trim/form, i.e. reverse trim/form.
Package surface matte finish VDI 11-13.

Transmission Line Pulsing (TLP) Plot (Pin 1 to Pin2)







#### Part Marking System





#### Part Numbering System <u>SP4022</u> - 01 F T G - C Blank= Unidirectional Considerational



#### **Ordering Information**

Part Number	Package	Marking	Min. Order Qty.
SP4022-01FTG	SOD323	12	3000
SP4022-01FTG-C	SOD323	12C	3000

#### Package Dimensions -SOD323





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Unit: mm

		SOD323			
Symbol	Millir	neters Inc		hes	
	Min	Max	Min	Max	
Α	0.80	1.14	0.031	0.045	
A1	0.00	0.10	0.000	0.004	
A2	0.80	1.04	0.031	0.014	
b	0.25	0.35	0.010	0.014	
C	0.08	0.15	0.003	0.006	
D	1.15	1.45	0.045	0.057	
E	1.60	1.90	0.063	0.075	
E1	2.44	2.75	0.096	0.108	
L1	0.22	0.45	0.009	0.018	

#### Embossed Carrier Tape & Reel Specification – SOD323



Symbol	Dimensions (mm)
A0	1.46 + / - 0.1
B0	2.90 + / - 0.1
W	8.0 +0.3 / - 0.10
D0	ø1.50 +0.1
D1	0.45 ~ 1.15
E1	1.75 + / - 0.10
E2	
F	3.50 + / - 0.10
P0	4.0 + / - 0.10
Р	4.0 + / - 0.10
P1	2.0 + / - 0.05
KO	1.25 + / - 0.1
т	0.254 + / - 0.02